





data sheet

largest memory, smallest package available

The HP workstation j6000 with UNIX[®] provides the capacity to deliver on your toughest designs and simulations. With industry leading performance, the HP j6000 gives EDA IC designers the large memory capacity they need to handle their ever-increasing data sets. MCAE engineers will cut design cycle time running compute intensive mechanical engineering applications.

Whether as a deskside configuration optimized for your office environment or a racked solution, the HP workstation j6000's performance and reliability will satisfy the most demanding engineer.

hp workstation j6000	feature	benefit	advantage
performance	2 PA-8600 RISC processors running at 552MHz	puts more compute and visualization power behind EDA and MCAE applications; provides higher application performance at a lower price	holds the fastest microprocessor on the market
	16GB synchronous DRAM capacity	supports analysis of larger models	delivers higher application performance; largest memory available
	1.5MB on-chip cache	enhances system performance with greater application speed and throughput; lowers cost	highly integrated microprocessor design minimizes system latency
	four-way set associative cache	requires less disk-to-cache access for instructions and data, providing higher per- formance	decreases the miss rate of direct mapped cache
	64x64 operating system and microprocessor	improves large processing performance, such as full-chip simulation, logic synthesis and design rule checking	furnishes large address spaces
	1.9GB/s I/O peak performance	delivers excellent file server performance	provides fastest data transfer to I/O
integration	efficient rack mountable design	saves space, particularly when used in your compute room; up to 20 systems per 2m rack	flexible configurations increase system ver- satility
graphics	hp visualize- <i>fxe</i> graphics accelerator	enables universal access to all types of data across diverse, cross-functional teams	provides full-featured, 3D capability across all HP workstation platforms
	hp visualize–fx ¹⁰ pro graphics accelerator	supports faster visualization and interactive work with large 3D models	delivers the world's fastest 3D graphics performance for mechanical design and analysis work
investment protection	binary compatibility with future PA-RISC and Intel® Itanium™ processors	protects your investment in applications, data and systems	ensures smooth transition to HP's next-gen- eration, high performance systems

hp workstation j6000 technical specifications

central processor		
type	PA-8600 552MHz 2	
clock frequency		
number of processors		
primary cache (on chip)		
total cache	1.5MB	
instruction	0.5MB	
data	1.OMB	
	ns/products/unix/performance.html	
main memory bus bandwidth		
	1.9GB/sec 120MHz SDRAM	
RAM type	1GB-16GB	
capacity	16	
memory slots	10	
PCI slots (3 total)		
PCI 4X	3 slots	
	1 slot: 256MB/s	
	2 slots: 500MB/s	

64-bit 3.3 volt 66MHz 20 watts per slot

80 pin SCA connector 2 drives maximum (hot pluggable) 18GB (10K RPM) 36GB (10K RPM) 36GB (15K RPM)

Trinitron CRT display

1920x1200 res flat ÉD Triniton CRT display

internal storage devices Ultra 2 SCSI LVD

	73GB (10K RPM)		
removable media			
CD-ROM or CD-RW*	1 internal		
*HP-UX 11.0 and higher			
external storage			
Ultra2 SCSĪ LVD	1 shared port – 13 devices		
NSE SCSI	1 shared port – 7 devices		
networking interface			
integrated	10/100 Base-Tx		
LAN data rate	10/100 Mbits/sec		
other I/O			
USB Series A	2 ports		
serial interface	(keyboard and mouse only) 2 ports		
audio			
type	integrated, CD-quality stereo		
inputs	stereo line in, MIC in		
outputs	stereo line-out, internal		
	speaker with frequency		
	range of 25-20,000Hz,		
	internal CD-ROM audio,		
	headphone		
monitor			
18.1" (18.1" viewable)	1280x1024 res LCD flat panel display		
19" (18" viewable)	1600x1200 res. Flat FD		
	Trinitron [®] CRT display		
21" (19.8" viewable)	1600x1200 res flat FD		

operating systems supported

24" (22.5" viewable)`

hp-ux 11i TCOE (Technical Computing Operating Environment) hp-ux 11.00 ACE9911 hp-ux 10.20 ACE9912

environmental specifications				
altitude operating non-operating	0-3000m (0-10,000 ft) 0-4500m (0-15,000 ft)			
temperature operating non-operating	0 to +35 degrees C -40 to +70 degrees C			
humidity operating vibration	15 to 80% (non condensing)			
operating random swept sine survival random survival safety emissions	0.21 G rms, 5-500Hz 0.5 G peak, 5-500Hz 2.09 G rms, 5-500Hz UL1950, CUL to CSA C22.2#950, and TUV GS Mark to EN60950/IEC950 FCC and CISPR Class A and VCCI Class A			
physical dimensions height width depth physical dimensions with rack kit height width depth	49.5cm (19.5 inches) 13.7cm (5.4 inches) 65.5cm (25.8 inches) 2 EIA units 48.3cm (19.0 inches) 62.2cm (24.5 inches)			
net weight minimum configuration fully loaded	18.2kg (40 lbs.) 21.8kg (48 lbs.)			
power requirements input current line frequency maximum power input	6 amps RMS max @ 100-120V 3 amps RMS max @ 220-240V 50-60Hz 600 watts*			
*maximum power – configuration will vary				

hp fxe	hp fx ¹⁰ pro
3 max	2 max
1600x1200	1600x1200
24/24DB**	24/24DB**
8 overlay	8 overlay
24-bit HŴ	24-bit HW
4-bit HW	4-bit HW
SW	8/8DB HW
Std. 9.5MB	Std. 110MB***
2 image	2 image
2 overlay	2 overlay
	3 max 1600x1200 24/24DB** 8 overlay 24-bit HW 4-bit HW SW Std. 9.5MB 2 image

* with full feature set and 75Mz refresh

** DB=double buffered

*** at 1280x1024 resolution

The hp workstation j6000 - power to invent in real time

For the latest information about HP workstations: http://www.hp.com/workstations

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